



## Material Content Data Sheet



Sales Product Name	1EDC30I12MH			Issued		11. December 2019		
MA#	MA005407379							
Package	PG-DSO-8-59			Weight*		287.42 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip_1	inorganic material	silicon	7440-21-3	2.068	0.72	0.72	7194	7194
chip_2	inorganic material	silicon	7440-21-3	0.801	0.28	0.28	2788	2788
leadframe	inorganic material	phosphorus	7723-14-0	0.025	0.01		88	
	non noble metal	zinc	7440-66-6	0.101	0.04		351	
	non noble metal	iron	7439-89-6	2.018	0.70		7022	
	non noble metal	copper	7440-50-8	81.947	28.51	29.26	285117	292578
wire	noble metal	gold	7440-57-5	0.310	0.11	0.11	1077	1077
encapsulation	organic material	carbon black	1333-86-4	0.594	0.21		2067	
	plastics	epoxy resin	-	23.165	8.06		80599	
	inorganic material	silicondioxide	60676-86-0	174.235	60.61	68.88	606208	688874
leadfinish	noble metal	palladium	7440-05-3	0.000	0.00		1	
	noble metal	silver	7440-22-4	0.000	0.00		1	
	noble metal	gold	7440-57-5	0.000	0.00		2	
	non noble metal	nickel	7440-02-0	0.496	0.17	0.17	1727	1731
plating	noble metal	silver	7440-22-4	0.000	0.00		1	
	noble metal	gold	7440-57-5	0.000	0.00		1	
	noble metal	palladium	7440-05-3	0.000	0.00		1	
	non noble metal	nickel	7440-02-0	0.052	0.02	0.02	182	185
glue	plastics	epoxy resin	-	0.400	0.14		1393	
	noble metal	silver	7440-22-4	1.201	0.42	0.56	4180	5573
*deviation	< 10%	Sum in total:			100.00			1000000

### Important Remarks:

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This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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